



# Film Capacitors

## EMI Suppression Capacitors (MKP)

**Series/Type:** B32021 ... B32026

**Date:** November 2019

### Typical applications

- Y2 class for interference suppression
- "Line to ground" applications.

### Climatic

- Max. operating temperature: 110 °C
- Climatic category (IEC 60068-1:2013): 40/110/56

### Construction

- Dielectric: polypropylene (MKP)
- Plastic case (UL 94 V-0)
- Epoxy resin sealing (UL 94 V-0)

### Features

- Very small dimensions
- Good self-healing properties
- High voltage capability
- RoHS-compatible
- Halogen-free capacitors available on request

### Terminals

- Parallel wire leads, lead-free tinned
- Special lead lengths available on request

### Marking

Manufacturer's logo, lot number, date code, rated capacitance (coded), capacitance tolerance (code letter), rated AC voltage (IEC), series number, sub-class (Y2), dielectric code (MKP), climatic category, passive flammability category, approvals.

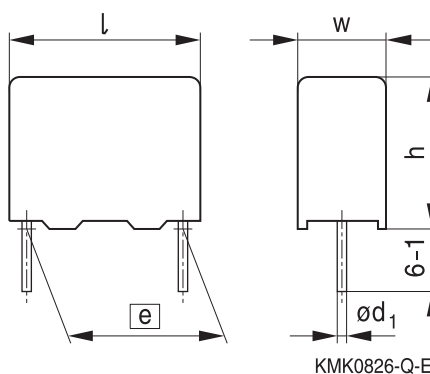
### Delivery mode

Bulk (untaped)

Taped (Ammo pack or reel)

For taping details, refer to chapter "Taping and packing"

### Dimensional drawing

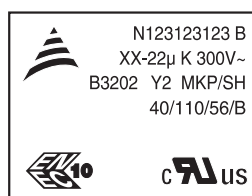


Dimensions in mm

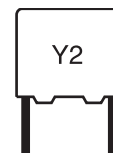
Lead spacing $e \pm 0.4$	Lead diameter $d_1 \pm 0.05$	Type
10	0.6	B32021
15 ... 27.5	0.8	B32022 ... B32024
37.5	1.0	B32026

### Marking example

(position of marks may vary):



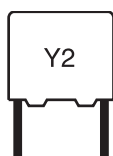
KMK1547-B



### Approvals

Approval marks	Standards	Certificate
	EN 60384-14:2014 IEC 60384-14:2013	40018909
	UL 1414:2000 UL 1283:2005	E97863 / E157153
	CSA C22.2 No.1:2004 CSA C22.2 No.8:2013	E97863 / E157153 (approved by UL)
	UL 60384-14:2014 CSA E60384-14:2013	E97863 (approved by UL)

Notes:	<p>Effective January 2014, only for EMI suppression capacitors:</p> <ul style="list-style-type: none"> <li>– UL 60384-14:2014 certification replaces both UL 1414:2000 and UL 1283:2005 standards.</li> <li>– CSA C22.2 No.1.2004 and CSA C22.2 No.8:2013 are replaced by CSA E60384-14:2013.</li> <li>– References like 1414, 1283 are removed from the capacitor marking.</li> </ul>
	<p>Capacitors under UL 1414:2000, UL 1283:2005 produced during or before 2013, are accepted under UL scope.</p>
	<p>Capacitors under CSA C22.2 No.1:2004 / CSA C22.2 No.8:2013 produced during or before 2013, are accepted under cUL scope.</p>

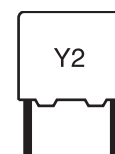


B32021 ... B32026

Y2 / 300 V AC

### Overview of available types

Lead spacing	10 mm	15 mm	22.5 mm	27.5 mm	37.5 mm
Type	B32021	B32022	B32023	B32024	B32026
$C_R$ ( $\mu$ F)					
0.0010					
0.0015					
0.0022					
0.0033					
0.0047					
0.0056					
0.0068					
0.0082					
0.010					
0.015					
0.022					
0.033					
0.047					
0.056					
0.068					
0.082					
0.10					
0.15					
0.22					
0.33					
0.39					
0.47					
0.56					
0.68					
0.82					
1.0					


**Ordering codes and packing units**

Lead spacing mm	C <sub>R</sub> μF	Max. dimensions w × h × l mm	Ordering code (composition see below)	Ammo pack pcs./MOQ	Reel pcs./MOQ	Untaped pcs./MOQ
10	0.0010	4.0 × 9.0 × 13.0	B32021A3102+***	4000	6800	4000
	0.0015	4.0 × 9.0 × 13.0	B32021A3152+***	4000	6800	4000
	0.0022	4.0 × 9.0 × 13.0	B32021A3222+***	4000	6800	4000
	0.0033	4.0 × 9.0 × 13.0	B32021A3332+***	4000	6800	4000
	0.0047	5.0 × 11.0 × 13.0	B32021A3472+***	3320	5200	4000
	0.0056	5.0 × 11.0 × 13.0	B32021A3562+***	3320	5200	4000
	0.0068	5.0 × 11.0 × 13.0	B32021A3682+***	3320	5200	4000
	0.0082	6.0 × 12.0 × 13.0	B32021A3822+***	2720	4400	4000
	0.010	6.0 × 12.0 × 13.0	B32021A3103M***	2720	4400	4000
15	0.010	5.0 × 10.5 × 18.0	B32022A3103+***	4680	5200	4000
	0.015	6.0 × 11.0 × 18.0	B32022A3153+***	3840	4400	4000
	0.022	6.0 × 12.0 × 18.0	B32022A3223M***	3840	4400	4000
	0.022	7.0 × 12.5 × 18.0	B32022B3223+***	3320	3600	4000
	0.033	8.0 × 14.0 × 18.0	B32022A3333+***	2920	3000	2000
	0.047	8.5 × 14.5 × 18.0	B32022A3473M***	2720	2800	2000
	0.047	9.0 × 17.5 × 18.0	B32022B3473+***	2560	2800	2000
	0.056	9.0 × 17.5 × 18.0	B32022A3563+***	2560	2800	2000
	0.068	9.0 × 17.5 × 18.0	B32022A3683M***	2560	2800	2000
	0.082	11.0 × 18.5 × 18.0	B32022A3823M***	—	2200	1200

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further intermediate capacitance values on request.

**Composition of ordering code**

+ = Capacitance tolerance code:

M = ±20%

K = ±10%

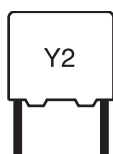
\*\*\* = Packaging code:

289 = Straight terminals, Ammo pack

189 = Straight terminals, Reel

003 = Straight terminals, untaped  
(lead length 3.2 ±0.3 mm)

000 = Straight terminals, untaped  
(lead length 6 – 1 mm)



B32021 ... B32026

Y2 / 300 V AC

### Ordering codes and packing units

Lead spacing mm	C <sub>R</sub> μF	Max. dimensions w × h × l mm	Ordering code (composition see below)	Ammo pack pcs./MOQ	Reel pcs./MOQ	Untaped pcs./MOQ
22.5	0.047	6.0 × 15.0 × 26.5	B32023A3473+***	2720	2800	2880
	0.056	6.0 × 15.0 × 26.5	B32023A3563M***	2720	2800	2880
	0.068	7.0 × 16.0 × 26.5	B32023A3683+***	2320	2400	2520
	0.068	7.5 × 14.5 × 26.5	B32023B3683M***	2200	2000	2280
	0.082	8.5 × 16.5 × 26.5	B32023A3823+***	1920	2000	2040
	0.10	8.5 × 16.5 × 26.5	B32023A3104M***	1920	2000	2040
	0.10	10.5 × 16.5 × 26.5	B32023B3104+***	1560	1600	2160
	0.15	10.5 × 18.5 × 26.5	B32023A3154M***	1560	1600	2160
	0.15	10.5 × 20.5 × 26.5	B32023B3154+***	—	—	2160
	0.22	12.0 × 22.0 × 26.5	B32023A3224M***	—	—	1800
	0.22	14.5 × 29.5 × 26.5	B32023B3224+***	—	—	1040
	0.33	14.5 × 29.5 × 26.5	B32023A3334+***	—	—	1040
	0.39	14.5 × 29.5 × 26.5	B32023A3394M***	—	—	1040
27.5	0.15	11.0 × 19.0 × 31.5	B32024A3154+***	—	1400	1280
	0.22	11.0 × 19.0 × 31.5	B32024A3224M***	—	1400	1280
	0.22	11.0 × 21.0 × 31.5	B32024B3224+***	—	1400	1280
	0.33	13.5 × 23.0 × 31.5	B32024A3334M***	—	1000	1040
	0.33	14.0 × 24.5 × 31.5	B32024B3334+***	—	—	1040
	0.47	15.0 × 24.5 × 31.5	B32024A3474M***	—	—	960
	0.47	16.0 × 32.0 × 31.5	B32024C3474+***	—	—	880

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Further intermediate capacitance values on request.

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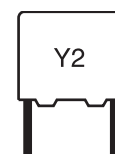
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003 = Straight terminals, untaped  
(lead length 3.2 ±0.3 mm)

000 = Straight terminals, untaped  
(lead length 6 – 1 mm)


**Ordering codes and packing units**

Lead spacing mm	C <sub>R</sub> μF	Max. dimensions w × h × l mm	Ordering code (composition see below)	Ammo pack pcs./MOQ	Reel pcs./MOQ	Untaped pcs./MOQ
27.5	0.47	18.0 × 27.5 × 31.5	B32024B3474+***	—	—	800
	0.56	16.0 × 32.0 × 31.5	B32024A3564+***	—	—	880
	0.68	18.0 × 33.0 × 31.5	B32024B3684+***	—	—	800
	0.68	19.0 × 30.0 × 31.5	B32024A3684M***	—	—	720
	0.68	21.0 × 31.0 × 31.5	B32024C3684+***	—	—	720
	0.82	22.0 × 36.5 × 31.5	B32024A3824+***	—	—	640
	1.0	22.0 × 36.5 × 31.5	B32024A3105M***	—	—	640
37.5	0.33	12.0 × 22.0 × 41.5	B32026A3334+***	—	—	1620
	0.47	14.0 × 25.0 × 41.5	B32026A3474+***	—	—	1380
	0.56	14.0 × 25.0 × 41.5	B32026A3564M***	—	—	1380
	0.56	16.0 × 28.5 × 41.5	B32026B3564+***	—	—	800
	0.68	16.0 × 28.5 × 41.5	B32026A3684+***	—	—	800
	0.82	16.0 × 28.5 × 41.5	B32026A3824M***	—	—	800
	0.82	18.0 × 32.5 × 41.5	B32026B3824+***	—	—	720
	1.0	18.0 × 32.5 × 41.5	B32026A3105M***	—	—	720
	1.0	20.0 × 39.5 × 42.0	B32026B3105+***	—	—	640

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further intermediate capacitance values on request.

**Composition of ordering code**

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K = ±10%

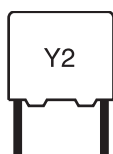
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B32021 ... B32026

Y2 / 300 V AC

### Technical data

Reference standard: IEC 60384-14:2013. All data given at T = 20 °C, unless otherwise specified.

Rated AC voltage (IEC 60384-14:2013)	300 V (50/60 Hz)
Maximum continuous DC voltage V <sub>DC</sub>	1500 V
Maximum continuous AC voltage V <sub>AC</sub>	480 V (50/60 Hz)
Max. operating temperature T <sub>op,max</sub>	+110 °C
DC test voltage	4000 V (C ≤ 0.33 μF), 3700 V (C > 0.33 μF), 2 s

*The repetition of this DC voltage test may damage the capacitor. Special care must be taken in case of use several capacitors in a parallel configuration.*

Dissipation factor tan δ (in 10 <sup>-3</sup> ) at 20 °C (upper limit values)		C <sub>R</sub> ≤ 0.33 μF	C <sub>R</sub> > 0.33 μF
	at 1 kHz	1	1
Insulation resistance R <sub>ins</sub> or time constant τ = C <sub>R</sub> · R <sub>ins</sub> at 100 V DC, 20 °C, rel. humidity ≤ 65% and for 60 s (minimum as-delivered values)	C <sub>R</sub> ≤ 0.33 μF		C <sub>R</sub> > 0.33 μF
	100 000 MΩ		30 000 s
Passive flammability category	B		
Capacitance tolerances (measured at 1 kHz)	±10% (K), ±20% (M)		

### Pulse handling capability

"dV/dt" represents the maximum permissible voltage change per unit of time for non-sinusoidal voltages, expressed in V/μs.

"k<sub>0</sub>" represents the maximum permissible pulse characteristic of the waveform applied to the capacitor, expressed in V<sup>2</sup>/μs.

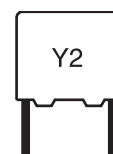
*Note:*

*The values of dV/dt and k<sub>0</sub> provided below must not be exceeded in order to avoid damaging the capacitor.*

### dV/dt and k<sub>0</sub> values

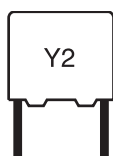
Lead spacing	10 mm	15 mm	22.5 mm	27.5 mm	37.5 mm
dV/dt in V/μs	800	600	500	400	300
k <sub>0</sub> in V <sup>2</sup> /μs	677 000	508 000	423 000	338 000	254 000





## Testing and Standards

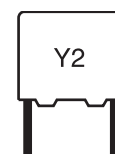
Test	Reference	Conditions of test	Performance requirements
Electrical parameters	IEC 60384-14:2013	Voltage Proof: Between terminals, 1500 V AC, 1 min. Terminals and enclosure: $2 V_R + 1500$ V AC Insulation resistance, $R_{ins}$ Capacitance, C Dissipation factor, $\tan \delta$	Within specified limits
Robustness of terminations	IEC 60068-2-21:2006	Tensile strength (test Ua1)	Capacitance and $\tan \delta$ within specified limits
		Wire diameter	
		0.5 < $d_1$ ≤ 0.8 mm	10 N
		0.8 < $d_1$ ≤ 1.25 mm	20 N
Resistance to soldering heat	IEC 60068-2-20:2008, test Tb, method 1A	Solder bath temperature at $260 \pm 5$ °C, immersion for 10 seconds	$\Delta C/C_0 \leq 5\%$ $\tan \delta$ within specified limits
Rapid change of temperature	IEC 60384-14:2013	$T_A$ = lower category temperature $T_B$ = upper category temperature Five cycles, duration $t = 30$ min.	No visible damage $ \Delta C/C_0  \leq 5\%$ $\tan \delta$ within specified limits
Vibration	IEC 60384-14:2013	Test $F_C$ : vibration sinusoidal Displacement: 0.75 mm Acceleration: 98 m/s <sup>2</sup> Frequency: 10 Hz ... 500 Hz Test duration: 3 orthogonal axes, 2 hours each axe	No visible damage
Bump	IEC 60384-14:2013	Test Eb: Total 4000 bumps with 400 m/s <sup>2</sup> mounted on PCB 6 ms duration	No visible damage $ \Delta C/C_0  \leq 5\%$ $\tan \delta$ within specified limits
Climatic sequence	IEC 60384-14:2013	Dry heat Tb / 16 h Damp heat cyclic, 1 <sup>st</sup> cycle +55 °C / 24 h / 95% ... 100% RH Cold Ta / 2 h Damp heat cyclic, 5 cycles +55 °C / 24 h / 95% ... 100% RH	No visible damage $ \Delta C/C_0  \leq 5\%$ $ \Delta \tan \delta  \leq 0.008$ for $C \leq 1 \mu F$ $ \Delta \tan \delta  \leq 0.005$ for $C > 1 \mu F$ Voltage proof $R_{ins} \geq 50\%$ of initial limit



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Y2 / 300 V AC

Test	Reference	Conditions of test	Performance requirements
Damp heat, steady state	IEC 60384-14:2013	Test Ca 40 °C / 93% RH / 56 days	No visible damage $ \Delta C/C_0  \leq 5\%$ $ \Delta \tan \delta  \leq 0.008$ for $C \leq 1 \mu\text{F}$ $ \Delta \tan \delta  \leq 0.005$ for $C > 1 \mu\text{F}$ Voltage proof $R_{\text{ins}} \geq 50\%$ of initial limit
Impulse test Endurance	IEC 60384-14:2013	3 impulses $T_b / 1.7 V_R / 1000$ hours, $1000 V_{\text{RMS}}$ for 0.1 s every hour	No visible damage $ \Delta C/C_0  \leq 10\%$ $ \Delta \tan \delta  \leq 0.008$ for $C \leq 1 \mu\text{F}$ $ \Delta \tan \delta  \leq 0.005$ for $C > 1 \mu\text{F}$ Voltage proof $R_{\text{ins}} \geq 50\%$ of initial limit
Passive flammability	IEC 60384-14:2013	Flame applied for a period of time depending on capacitor volume	B
Active flammability	IEC 60384-14:2013	20 discharges at $2.5 \text{ kV} + V_R$	The cheesecloth shall not burn with a flame



## Mounting guidelines

### 1 Soldering

#### 1.1 Solderability of leads

The solderability of terminal leads is tested to IEC 60068-2-20:2008, test Ta, method 1.

Before a solderability test is carried out, terminals are subjected to accelerated ageing (to IEC 60068-2-2:2007, test Ba: 4 h exposure to dry heat at 155 °C). Since the ageing temperature is far higher than the upper category temperature of the capacitors, the terminal wires should be cut off from the capacitor before the ageing procedure to prevent the solderability being impaired by the products of any capacitor decomposition that might occur.

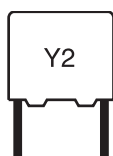
Solder bath temperature	235 ±5 °C
Soldering time	2.0 ±0.5 s
Immersion depth	2.0 +0/−0.5 mm from capacitor body or seating plane
Evaluation criteria:	
Visual inspection	Wetting of wire surface by new solder ≥90%, free-flowing solder

#### 1.2 Resistance to soldering heat

Resistance to soldering heat is tested to IEC 60068-2-20:2008, test Tb, method 1.

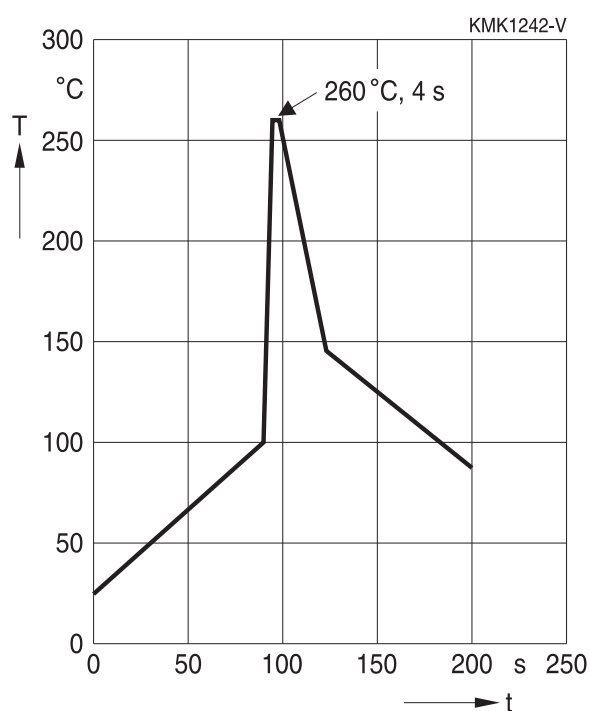
Conditions:

Series	Solder bath temperature	Soldering time
MKT boxed (except 2.5 × 6.5 × 7.2 mm) coated uncoated (lead spacing >10 mm)	260 ±5 °C	10 ±1 s
MFP MKP (lead spacing >7.5 mm)		
MKT boxed (case 2.5 × 6.5 × 7.2 mm)		5 ±1 s
MKP (lead spacing ≤7.5 mm)		<4 s
MKT uncoated (lead spacing ≤10 mm) insulated (B32559)		recommended soldering profile for MKT uncoated (lead spacing ≤ 10 mm) and insulated (B32559)



B32021 ... B32026

Y2 / 300 V AC

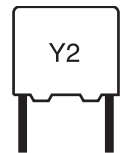


Immersion depth	2.0 +0/−0.5 mm from capacitor body or seating plane
Shield	Heat-absorbing board, (1.5 ±0.5) mm thick, between capacitor body and liquid solder
Evaluation criteria:	
Visual inspection	No visible damage
$\Delta C/C_0$	2% for MKT/MKP/MFP 5% for EMI suppression capacitors
$\tan \delta$	As specified in sectional specification

### 1.3 General notes on soldering

Permissible heat exposure loads on film capacitors are primarily characterized by the upper category temperature  $T_{max}$ . Long exposure to temperatures above this type-related temperature limit can lead to changes in the plastic dielectric and thus change irreversibly a capacitor's electrical characteristics. For short exposures (as in practical soldering processes) the heat load (and thus the possible effects on a capacitor) will also depend on other factors like:

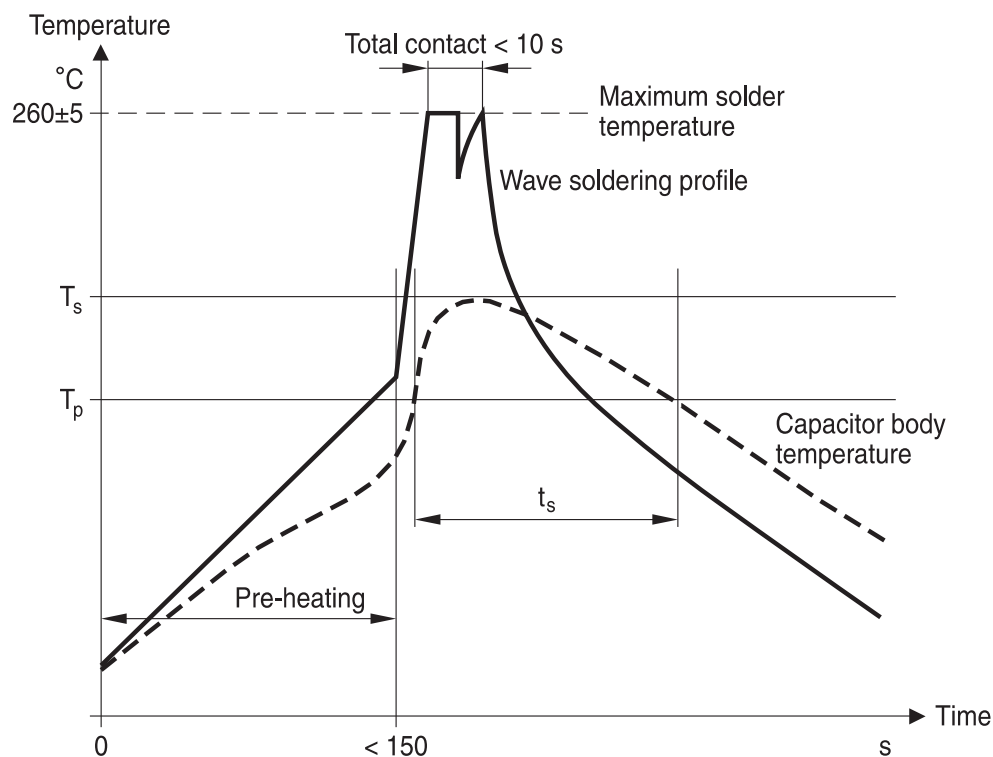
- Pre-heating temperature and time
- Forced cooling immediately after soldering
- Terminal characteristics:  
diameter, length, thermal resistance, special configurations (e.g. crimping)
- Height of capacitor above solder bath
- Shadowing by neighboring components
- Additional heating due to heat dissipation by neighboring components
- Use of solder-resist coatings



The overheating associated with some of these factors can usually be reduced by suitable countermeasures. For example, if a pre-heating step cannot be avoided, an additional or reinforced cooling process may possibly have to be included.

### Recommendations

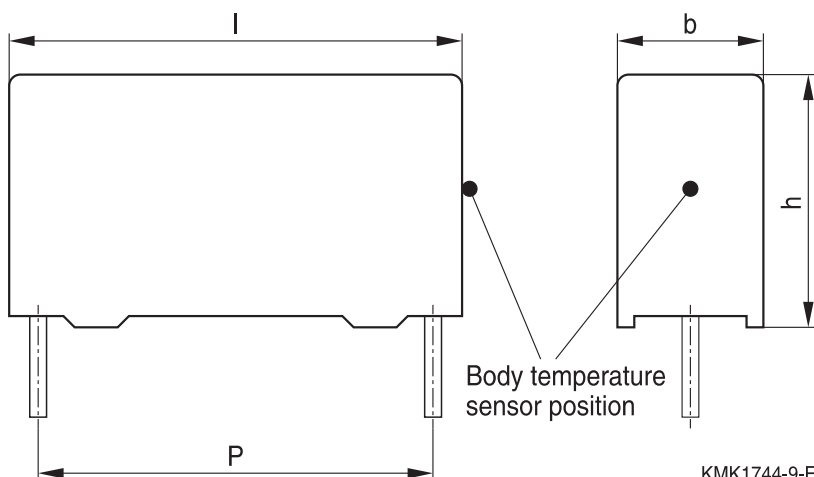
As a reference, the recommended wave soldering profile for our film capacitors is as follows:



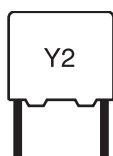
$T_s$ : Capacitor body maximum temperature at wave soldering

$T_p$ : Capacitor body maximum temperature at pre-heating

KMK1745-A-E



KMK1744-9-E



B32021 ... B32026

Y2 / 300 V AC

Body temperature should follow the description below:

- MKP capacitor
  - During pre-heating:  $T_p \leq 110 \text{ }^\circ\text{C}$
  - During soldering:  $T_s \leq 120 \text{ }^\circ\text{C}$ ,  $t_s \leq 45 \text{ s}$
- MKT capacitor
  - During pre-heating:  $T_p \leq 125 \text{ }^\circ\text{C}$
  - During soldering:  $T_s \leq 160 \text{ }^\circ\text{C}$ ,  $t_s \leq 45 \text{ s}$

When SMD components are used together with leaded ones, the film capacitors should not pass into the SMD adhesive curing oven. The leaded components should be assembled after the SMD curing step.

Leaded film capacitors are not suitable for reflow soldering.

In order to ensure proper conditions for manual or selective soldering, the body temperature of the capacitor ( $T_s$ ) must be  $\leq 120 \text{ }^\circ\text{C}$ .

One recommended condition for manual soldering is that the tip of the soldering iron should be  $< 360 \text{ }^\circ\text{C}$  and the soldering contact time should be no longer than 3 seconds.

For uncoated MKT capacitors with lead spacings  $\leq 10 \text{ mm}$  (B32560/B32561) the following measures are recommended:

- pre-heating to not more than  $110 \text{ }^\circ\text{C}$  in the preheater phase
- rapid cooling after soldering

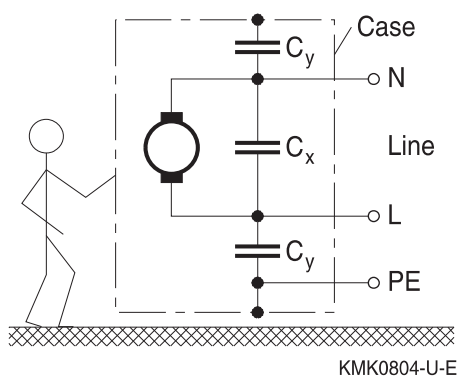
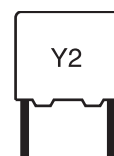
Please refer to our Film Capacitors Data Book in case more details are needed.

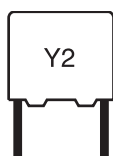
### Application note

A Y capacitor to be connected between AC lines and the Frame Ground (FG) has an effect of emitting common mode current to the FG. Leak current corresponding in frequency and voltage to the AC power supply flows in the Y capacitor.

As the capacity of a Y capacitor grows, leak current also increases. This can cause electric shock. Therefore, UL and other safety standards restrict the capacity so that the amount of leak current does not exceed a certain level. Usually, two Y capacitors are used, as shown in Figure below. As AC lines are connected with capacitors, they are effective in reducing differential mode noises. In particular, they are effective for high frequency ranges of 8 to 10 MHz.

Example of EMI suppression, typical application:





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Y2 / 300 V AC

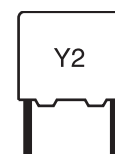
## Cautions and warnings

- Do not exceed the upper category temperature (UCT).
- Do not apply any mechanical stress to the capacitor terminals.
- Avoid any compressive, tensile or flexural stress.
- Do not move the capacitor after it has been soldered to the PC board.
- Do not pick up the PC board by the soldered capacitor.
- Do not place the capacitor on a PC board whose PTH hole spacing differs from the specified lead spacing.
- Do not exceed the specified time or temperature limits during soldering.
- Avoid external energy inputs, such as fire or electricity.
- Avoid overload of the capacitors.
- Consult us if application is with severe temperature and humidity condition.
- There are no serviceable or repairable parts inside the capacitor. Opening the capacitor or any attempts to open or repair the capacitor will void the warranty and liability of TDK Electronics.
- Please note that the standards referred to in this publication may have been revised in the meantime.

The table below summarizes the safety instructions that must always be observed. A detailed description can be found in the relevant sections of the chapters "General technical information" and "Mounting guidelines".

Topic	Safety information	Reference chapter "General technical information"
Storage conditions	Make sure that capacitors are stored within the specified range of time, temperature and humidity conditions.	4.5 "Storage conditions"
Flammability	Avoid external energy, such as fire or electricity (passive flammability), avoid overload of the capacitors (active flammability) and consider the flammability of materials.	5.3 "Flammability"
Resistance to vibration	Do not exceed the tested ability to withstand vibration. The capacitors are tested to IEC 60068-2-6:2007. TDK Electronics offers film capacitors specially designed for operation under more severe vibration regimes such as those found in automotive applications. Consult our catalog "Film Capacitors for Automotive Electronics".	5.2 "Resistance to vibration"





Topic	Safety information	Reference chapter "Mounting guidelines"
Soldering	Do not exceed the specified time or temperature limits during soldering.	1 "Soldering"
Cleaning	Use only suitable solvents for cleaning capacitors.	2 "Cleaning"
Embedding of capacitors in finished assemblies	When embedding finished circuit assemblies in plastic resins, chemical and thermal influences must be taken into account. Caution: Consult us first, if you also wish to embed other uncoated component types!	3 "Embedding of capacitors in finished assemblies"

### Design of our capacitors

Our EMI capacitors use polypropylene (PP) film metalized with a thin layer of Zinc (Zn). The following key points have made this design suitable to IEC/UL testing, holding a minimum size.

- Overvoltage AC capability with very high temperature Endurance test of IEC 60384-14:2013 (4<sup>th</sup> edition) / UL 60384-14:2014 (2<sup>nd</sup> edition) must be performed at  $1.25 \times V_R$  at maximum temperature, during 1000 hours, with a capacitance drift less than 10%.
- Higher breakdown voltage withstanding if compared to other film metallizations, like Aluminum. IEC 60384-14:2013 (4<sup>th</sup> edition) / UL 60384-14:2014 (2<sup>nd</sup> edition) establishes high voltage tests performed at  $4.3 \times V_R - 1$  minute, impulse testing at 2500 V for  $C = 1 \mu\text{F}$  and active flammability tests.
- Damp heat steady state: 40 °C/ 93% RH / 56 days. (without voltage or current load)

### Effect of humidity on capacitance stability

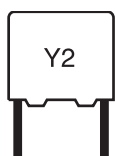
Long contact of a film capacitor with humidity can produce irreversible effects. Direct contact with liquid water or excess exposure to high ambient humidity or dew will eventually remove the film metallization and thus destroy the capacitor. Plastic boxed capacitors must be properly tested in the final application at the worst expected conditions of temperature and humidity in order to check if any parameter drift may provoke a circuit malfunction.

In case of penetration of humidity through the film, the layer of Zinc can be degraded, specially under AC operation (change of polarity), accelerated by the temperature, provoking an increment of the serial resistance of the electrode and eventually a reduction of the capacitance value. For DC operation, the parameter drift is much less.

Plastic boxes and resins can not protect 100% against humidity. Metal enclosures, resin potting or coatings or similar measures by customers in their applications will offer additional protection against humidity penetration.

### Display of ordering codes for TDK Electronics products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications, on the company website, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the order-

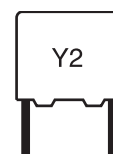


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**Y2 / 300 V AC**

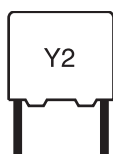
ing codes are due to different processes employed and do not affect the specifications of the respective products.

Detailed information can be found on the Internet under [www.tdk-electronics.tdk.com/orderingcodes](http://www.tdk-electronics.tdk.com/orderingcodes).



## Symbols and terms

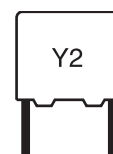
Symbol	English	German
$\alpha$	Heat transfer coefficient	Wärmeübergangszahl
$\alpha_C$	Temperature coefficient of capacitance	Temperaturkoeffizient der Kapazität
A	Capacitor surface area	Kondensatoroberfläche
$\beta_C$	Humidity coefficient of capacitance	Feuchtekoeffizient der Kapazität
C	Capacitance	Kapazität
$C_R$	Rated capacitance	Nennkapazität
$\Delta C$	Absolute capacitance change	Absolute Kapazitätsänderung
$\Delta C/C$	Relative capacitance change (relative deviation of actual value)	Relative Kapazitätsänderung (relative Abweichung vom Ist-Wert)
$\Delta C/C_R$	Capacitance tolerance (relative deviation from rated capacitance)	Kapazitätstoleranz (relative Abweichung vom Nennwert)
dt	Time differential	Differentielle Zeit
$\Delta t$	Time interval	Zeitintervall
$\Delta T$	Absolute temperature change (self-heating)	Absolute Temperaturänderung (Selbsterwärmung)
$\Delta \tan \delta$	Absolute change of dissipation factor	Absolute Änderung des Verlustfaktors
$\Delta V$	Absolute voltage change	Absolute Spannungsänderung
dV/dt	Time differential of voltage function (rate of voltage rise)	Differentielle Spannungsänderung (Spannungsflankensteilheit)
$\Delta V/\Delta t$	Voltage change per time interval	Spannungsänderung pro Zeitintervall
E	Activation energy for diffusion	Aktivierungsenergie zur Diffusion
ESL	Self-inductance	Eigeninduktivität
ESR	Equivalent series resistance	Ersatz-Serienwiderstand
f	Frequency	Frequenz
$f_1$	Frequency limit for reducing permissible AC voltage due to thermal limits	Grenzfrequenz für thermisch bedingte Reduzierung der zulässigen Wechselspannung
$f_2$	Frequency limit for reducing permissible AC voltage due to current limit	Grenzfrequenz für strombedingte Reduzierung der zulässigen Wechselspannung
$f_r$	Resonant frequency	Resonanzfrequenz
$F_D$	Thermal acceleration factor for diffusion	Therm. Beschleunigungsfaktor zur Diffusion
$F_T$	Derating factor	Deratingfaktor
i	Current (peak)	Stromspitze
$I_C$	Category current (max. continuous current)	Kategoriestrom (max. Dauerstrom)



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Symbol	English	German
$I_{RMS}$	(Sinusoidal) alternating current, root-mean-square value	(Sinusförmiger) Wechselstrom
$i_z$	Capacitance drift	Inkonstanz der Kapazität
$k_0$	Pulse characteristic	Impuls Kennwert
$L_S$	Series inductance	Serieninduktivität
$\lambda$	Failure rate	Ausfallrate
$\lambda_0$	Constant failure rate during useful service life	Konstante Ausfallrate in der Nutzungsphase
$\lambda_{test}$	Failure rate, determined by tests	Experimentell ermittelte Ausfallrate
$P_{diss}$	Dissipated power	Abgegebene Verlustleistung
$P_{gen}$	Generated power	Erzeugte Verlustleistung
$Q$	Heat energy	Wärmeenergie
$\rho$	Density of water vapor in air	Dichte von Wasserdampf in Luft
$R$	Universal molar constant for gases	Allg. Molarkonstante für Gas
$R$	Ohmic resistance of discharge circuit	Ohmscher Widerstand des Entladekreises
$R_i$	Internal resistance	Innenwiderstand
$R_{ins}$	Insulation resistance	Isolationswiderstand
$R_P$	Parallel resistance	Parallelwiderstand
$R_S$	Series resistance	Serienwiderstand
$S$	severity (humidity test)	Schärfegrad (Feuchtetest)
$t$	Time	Zeit
$T$	Temperature	Temperatur
$\tau$	Time constant	Zeitkonstante
$\tan \delta$	Dissipation factor	Verlustfaktor
$\tan \delta_D$	Dielectric component of dissipation factor	Dielektrischer Anteil des Verlustfaktors
$\tan \delta_P$	Parallel component of dissipation factor	Parallelanteil des Verlustfaktors
$\tan \delta_S$	Series component of dissipation factor	Serienanteil des Verlustfaktors
$T_A$	Temperature of the air surrounding the component	Temperatur der Luft, die das Bauteil umgibt
$T_{max}$	Upper category temperature	Obere Kategorietemperatur
$T_{min}$	Lower category temperature	Untere Kategorietemperatur
$t_{OL}$	Operating life at operating temperature and voltage	Betriebszeit bei Betriebstemperatur und -spannung
$T_{op}$	Operating temperature, $T_A + \Delta T$	Betriebstemperatur, $T_A + \Delta T$
$T_R$	Rated temperature	Nenntemperatur
$T_{ref}$	Reference temperature	Referenztemperatur
$t_{SL}$	Reference service life	Referenz-Lebensdauer



Symbol	English	German
$V_{AC}$	AC voltage	Wechselspannung
$V_C$	Category voltage	Kategorie <span>spannung</span>
$V_{C,RMS}$	Category AC voltage	(Sinusförmige) Kategorie-Wechselspannung
$V_{CD}$	Corona-discharge onset voltage	Teilentlade-Einsatzspannung
$V_{ch}$	Charging voltage	Ladespannung
$V_{DC}$	DC voltage	Gleichspannung
$V_{FB}$	Fly-back capacitor voltage	Spannung (Flyback)
$V_i$	Input voltage	Eingangsspannung
$V_o$	Output voltage	Ausgangsspannung
$V_{op}$	Operating voltage	Betriebsspannung
$V_p$	Peak pulse voltage	Impuls-Spitzen <span>spannung</span>
$V_{pp}$	Peak-to-peak voltage Impedance	Spannungshub
$V_R$	Rated voltage	Nennspannung
$\hat{V}_R$	Amplitude of rated AC voltage	Amplitude der Nenn-Wechselspannung
$V_{RMS}$	(Sinusoidal) alternating voltage, root-mean-square value	(Sinusförmige) Wechselspannung
$V_{SC}$	S-correction voltage	Spannung bei Anwendung "S-correction"
$V_{sn}$	Snubber capacitor voltage	Spannung bei Anwendung "Beschaltung"
$Z$	Impedance	Scheinwiderstand
$e$	Lead spacing	Rastermaß

## Important notes

The following applies to all products named in this publication:

1. Some parts of this publication contain **statements about the suitability of our products for certain areas of application**. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out **that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application**. As a rule, we are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether a product with the properties described in the product specification is suitable for use in a particular customer application.
2. We also point out that **in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified**. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or lifesaving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
3. **The warnings, cautions and product-specific notes must be observed.**
4. In order to satisfy certain technical requirements, **some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous)**. Useful information on this will be found in our Material Data Sheets on the Internet ([www.tdk-electronics.tdk.com/material](http://www.tdk-electronics.tdk.com/material)). Should you have any more detailed questions, please contact our sales offices.
5. We constantly strive to improve our products. Consequently, **the products described in this publication may change from time to time**. The same is true of the corresponding product specifications. Please check therefore to what extent product descriptions and specifications contained in this publication are still applicable before or when you place an order. We also **reserve the right to discontinue production and delivery of products**. Consequently, we cannot guarantee that all products named in this publication will always be available. The aforementioned does not apply in the case of individual agreements deviating from the foregoing for customer-specific products.
6. Unless otherwise agreed in individual contracts, **all orders are subject to our General Terms and Conditions of Supply**.

## Important notes

7. **Our manufacturing sites serving the automotive business apply the IATF 16949 standard.** The IATF certifications confirm our compliance with requirements regarding the quality management system in the automotive industry. Referring to customer requirements and customer specific requirements (“CSR”) TDK always has and will continue to have the policy of respecting individual agreements. Even if IATF 16949 may appear to support the acceptance of unilateral requirements, we hereby like to emphasize that **only requirements mutually agreed upon can and will be implemented in our Quality Management System.** For clarification purposes we like to point out that obligations from IATF 16949 shall only become legally binding if individually agreed upon.
8. The trade names EPCOS, CeraCharge, CeraDiode, CeraLink, CeraPad, CeraPlas, CSMP, CTVS, DeltaCap, DigiSiMic, ExoCore, FilterCap, FormFit, LeaXield, MiniBlue, MiniCell, MKD, MKK, MotorCap, PCC, PhaseCap, PhaseCube, PhaseMod, PhiCap, PowerHap, PQSine, PQvar, SIFERRIT, SIFI, SIKOREL, SilverCap, SIMDAD, SiMic, SIMID, SineFormer, SIOV, ThermoFuse, WindCap are **trademarks registered or pending** in Europe and in other countries. Further information will be found on the Internet at [www.tdk-electronics.tdk.com/trademarks](http://www.tdk-electronics.tdk.com/trademarks).

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